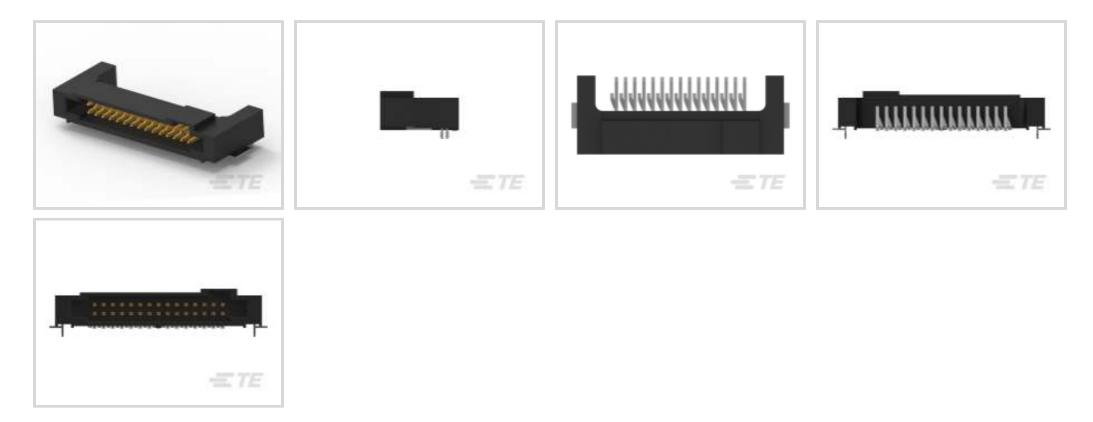
104894-8 - ACTIVE

AMPMODU | AMPMODU 50/50 Grid

TE Internal #: 104894-8 PCB Mount Header, Right Angle, Board-to-Board, 80 Position, 1.27 mm [.05 in] Centerline, Fully Shrouded, Gold, Surface Mount, AMPMODU 50/50 Grid

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Right Angle

Connector System: Board-to-Board

Number of Positions: 80

Number of Rows: 2

Features

E

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Right Angle
Number of Positions	80
Number of Rows	2
Electrical Characteristics	
Dielectric Withstanding Voltage (Max)	300 VAC
Operating Voltage	30 VAC
Body Features	

PCB Mount Header, Right Angle, Board-to-Board, 80 Position, 1.27 mm [.05 in] Centerline, Fully Shrouded, Gold, Surface Mount, AMPMODU 50/50 Grid



PCB Retention Feature Material	Copper Alloy
PCB Retention Feature Plating Material	Tin-Lead over Nickel
Connector Profile	Standard
Primary Product Color	Black
Contact Features	
	150 µin
Mating Pin Diameter	.46 mm[.018 in]
Contact Shape & Form	Square
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Brass
Contact Mating Area Plating Material	Gold
Contact Type	Pin
Contact Current Rating (Max)	.5 A
Termination Features	
Round Termination Post & Tail Diameter	.46 mm[.018 in]
Termination Method to Printed Circuit Board	Surface Mount

Mechanical Attachment

PCB Mount Retention Type	Hold-Down Post
Mating Alignment	With
Mating Alignment Type	Keyed
PCB Mount Retention	With
Housing Features	
Centerline (Pitch)	1.27 mm[.05 in]
Housing Material	Thermoplastic
Dimensions	
Row-to-Row Spacing	1.27 mm[.05 in]
Usage Conditions	
Operating Temperature Range	-65 – 105 °C
Operation/Application	
Solder Process Feature	Board Standoff

PCB Mount Header, Right Angle, Board-to-Board, 80 Position, 1.27 mm [.05 in] Centerline, Fully Shrouded, Gold, Surface Mount, AMPMODU 50/50 Grid



Industry Standards

Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	8
Packaging Type	Box, Tube

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) SVHC > Threshold: Pb (40% in Component Part) Aticle Safe Usage Statements! Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Halogen Content

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

PCB Mount Header, Right Angle, Board-to-Board, 80 Position, 1.27 mm [.05 in] Centerline, Fully Shrouded, Gold, Surface Mount, AMPMODU 50/50 Grid



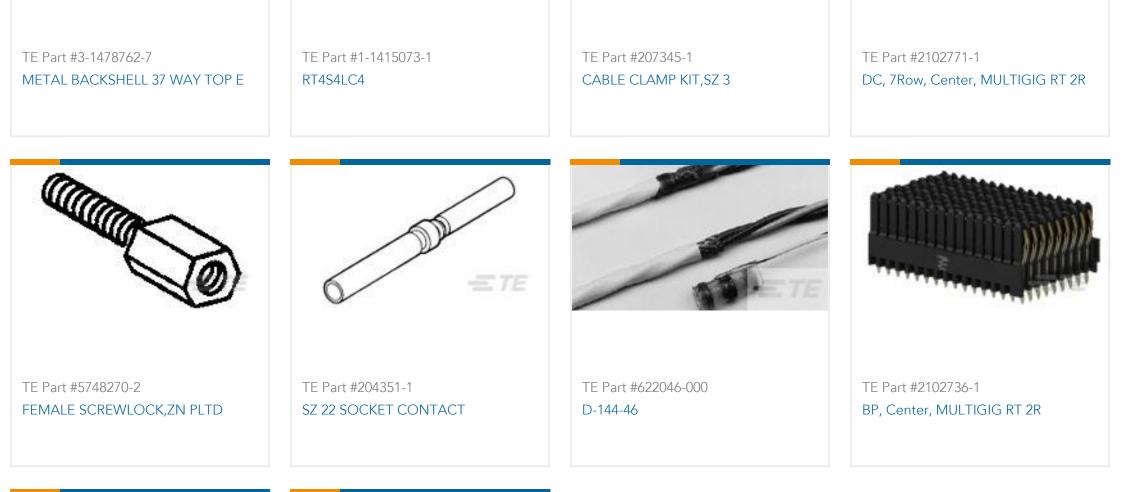


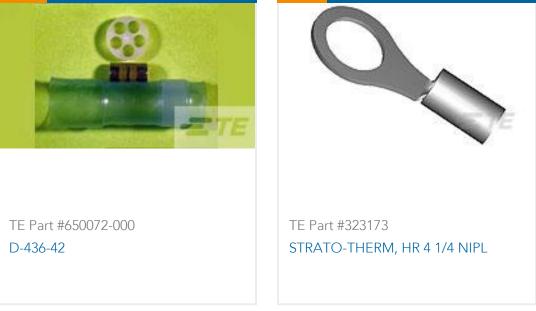
Also in the Series AMPMODU 50/50 Grid



Customers Also Bought







PCB Mount Header, Right Angle, Board-to-Board, 80 Position, 1.27 mm [.05 in] Centerline, Fully Shrouded, Gold, Surface Mount, AMPMODU 50/50 Grid



Documents

Product Drawings 80 50/50 GRID RA HDR

English

CAD Files

Customer View Model ENG_CVM_104894-8_J.3d_igs.zip

English

Customer View Model

ENG_CVM_104894-8_J.3d_stp.zip

English

Customer View Model

ENG_CVM_104894-8_J.2d_dxf.zip

English

3D PDF

English

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Product Specifications

Application Specification

English

Product Environmental Compliance TE Material Declaration

English

Agency Approvals UL Report

English